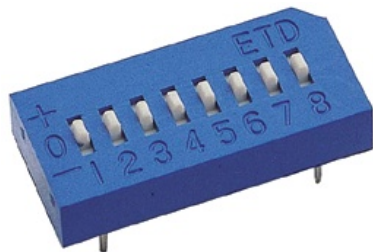


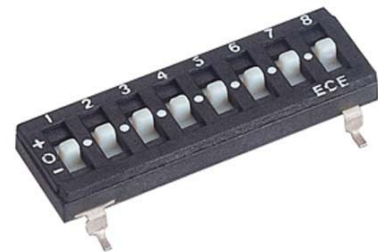
## ETD/ETA/ETS SERIES TRI-STATE TYPE



**ETD**



**ETA**



**ETS**

### ■ FEATURES

- With three state (1, open, 0) setting function, especially suitable for encoding/decoding of tri-state encoder/decoder integrated circuit to obtain more security codes than traditional two-state (1,0) operation. For instance, 9 bits with tri-state gets 19,683 ( $3^9$ ) codes, while two-state has 512 ( $2^9$ ) codes, gains 38 times more codes with a ECE tri-state DIP Switch.
- Bottom sealed to ensure free of flux immersion during wave soldering.
- All plastics are UL 94V-0 grade fire retardant.
- Gold plated contact to ensure low contact resistance and Tin plated terminals to prevent contamination during soldering.
- Twin contacts designed to ensure stable contact.
- Ideal for coding tele-communication, transceiving, remote control and burglar alarm systems which use integrated circuits with tri-state coding systems.

### ■ APPLICATIONS

- Numerical setting for computer terminal equipment
- Price setting for vending machines
- Programming for game machines
- Programming for industrial equipment and measuring instruments

### ■ SPECIFICATIONS

#### 1.ELECTRICAL

● Contact rating	
switching	25mA, 24VDC
non-switching	100mA

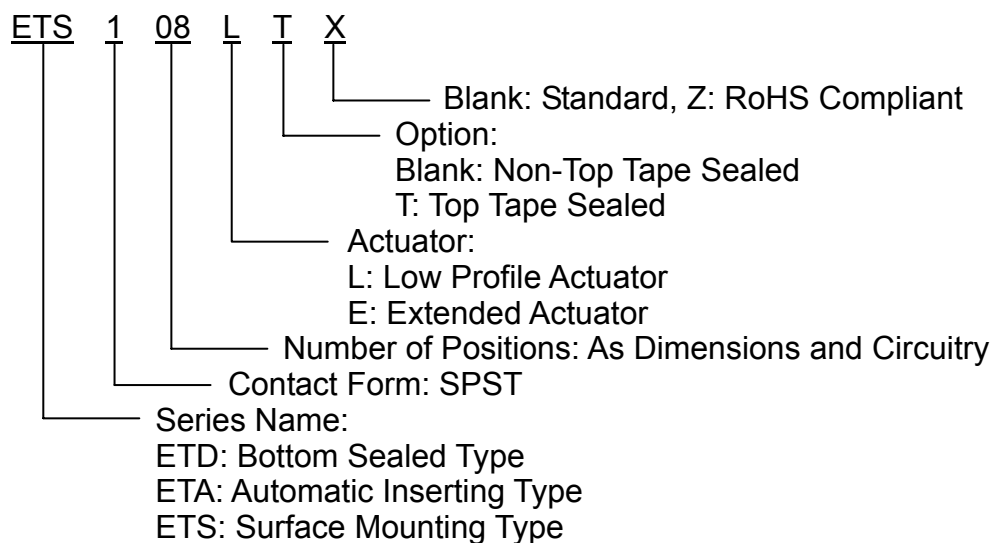


● Contact resistance	
initial	50mΩ Max.
after life test	100mΩ Max.
● Insulation resistance	1000MΩ Min. at 100VDC
● Dielectric strength	500VDC Min. for 60 seconds
● Capacitance between adjacent switches 5pF Max.	

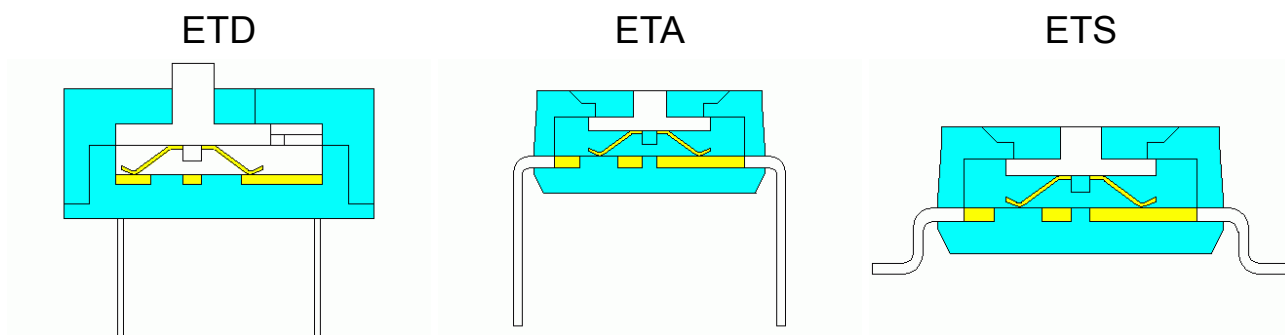
## 2.MECHANICAL and ENVIRONMENTAL

● Temperature rating	operating	-25°C to +70°C
	storage	-40°C to +85°C
● Operation force	800g Max.	
● Mechanical life	2000 operations	
● Humidity	95% RH, 40°C for 96 Hrs.	
● Vibration	Per MIL-STD-202F, method 204D.	
● Solderability (for through hole type)	after flux 230±5°C for 5±0.5 seconds, 95% coverage	
● Resistance to soldering heat (for through hole type)	260±5°C for 5±1 seconds.	
● Reflow soldering heat for SMT type (reference only)	<p>Max. 260 °C 240 °C 180 °C 150 °C</p> <p>Temperature (°C)</p> <p>120-150 sec 20 sec Max. Time (sec)</p>	

## ■ PART NUMBERING SYSTEM



## ■ CONSTRUCTION



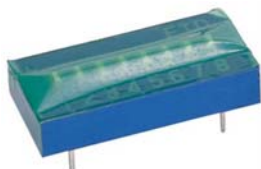
## ■ OPTIONS

### 1. Tape Sealed

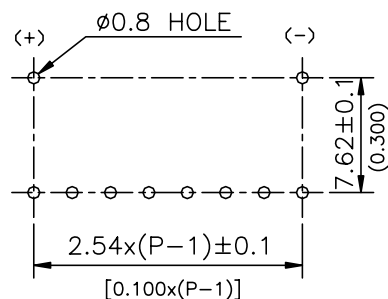
ETDxxxET

ETSxxxLT

ETAxxxLT



### 2. Reverse P.C.B. LAYOUT available

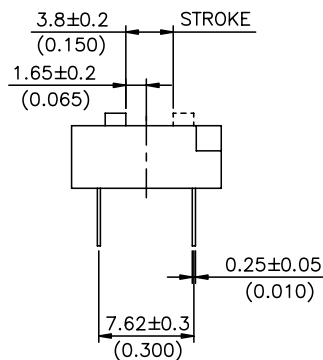
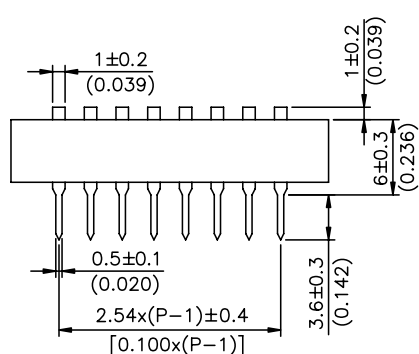
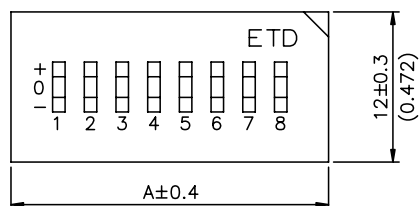


## DIMENSIONS AND CIRCUITRY

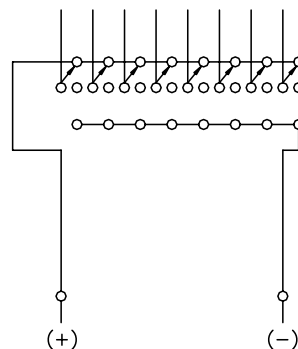
### ETD SERIES

Dimension A UNIT:mm(inch)

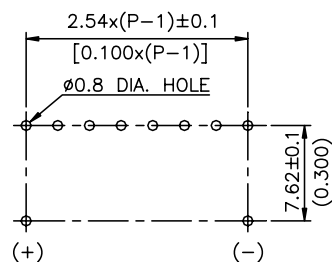
Positions	4	5	6	7	8	9	10
A	15.30 (0.602)	17.84 (0.702)	20.38 (0.802)	22.92 (0.902)	25.46 (1.002)	28.00 (1.102)	30.54 (1.202)



### CIRCUIT DIAGRAM



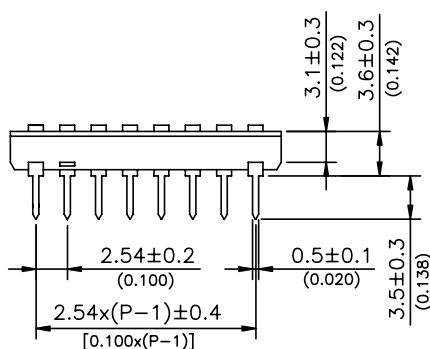
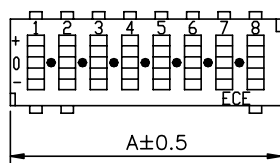
### P.C.B LAYOUT (TOP VIEW)



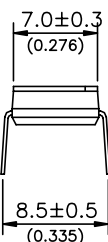
### ETA SERIES

Dimension A UNIT:mm(inch)

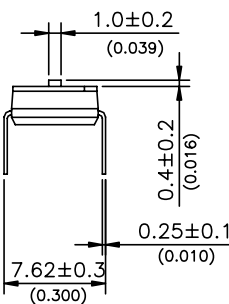
Positions	2	3	4	5	6	7	8	9	10	12
A	6.88 (0.263)	9.22 (0.363)	11.76 (0.463)	14.30 (0.563)	16.84 (0.663)	19.38 (0.763)	21.92 (0.863)	24.46 (0.963)	27.00 (1.063)	32.08 (1.263)



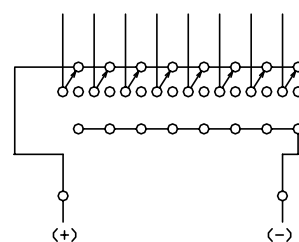
### (L)TYPE



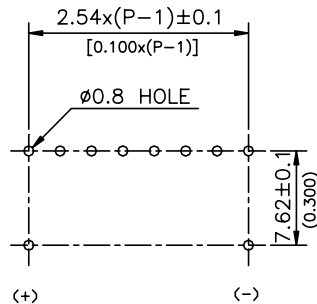
### (E)TYPE



### CIRCUIT DIAGRAM



### P.C.B LAYOUT (TOP VIEW)

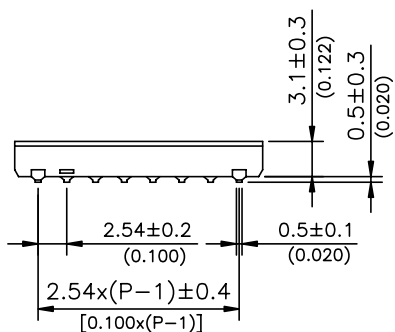
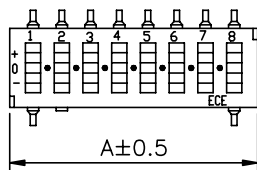


## ETS SERIES

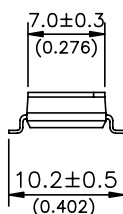
Dimension A

UNIT: mm(inch)

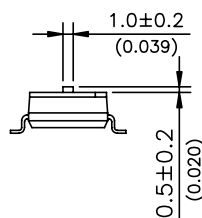
Positions	2	3	4	5	6	7	8	9	10	12
A	6.88 (0.263)	9.22 (0.363)	11.76 (0.463)	14.30 (0.563)	16.84 (0.663)	19.38 (0.763)	21.92 (0.863)	24.46 (0.963)	27.00 (1.063)	32.08 (1.263)



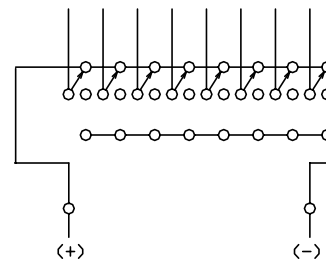
(L)TYPE



(E)TYPE



## CIRCUIT DIAGRAM



## P.C.B LAYOUT (TOP VIEW)

